



COPY OF PAPERS
ORIGINALLY FILED

Attorney Docket no: SEL 137 DIV

#910
Amndt
J. McMillan
8/29/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

TECHNOLOGY CENTER
AUG 26 2002
RECEIVED

In re Application of:

Yamazaki et al.

Serial No.: 09/821,473

Filed: March 29, 2001

For: Semiconductor Device Provided With
Semiconductor Circuit Made of
Semiconductor Element and Method Of
The Same

Examiner: H. Lee

Art Unit: 2823

I hereby certify that this correspondence is being
deposited with the United States Postal Service as
first class mail in an envelope addressed to:
the Assistant Commissioner for Patents, Washington
D.C. 20231 on August 12, 2002
(Date of Deposit)

Rachelle Hammerquist
Name of applicant, assignee, or Registered Rep
Rachelle Hammerquist
Signature Date 8-12-02

Commissioner for Patents
Washington D.C. 20231

AMENDMENT C

In response to the Final Rejection of May 10, 2002, a RCE being submitted herewith, please
amend the above-identified application as follows:

IN THE CLAIMS:

Please amend the claims as follows:

Cancel Claims ~~46~~, ~~54~~ and 55.

Please add the following new claims:

8 ~~56~~ (New). A method of fabricating a semiconductor device comprising:

forming a gate wiring over a substrate;

D1

47

D